

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	
CONVEYING PARTY DATA		
	Name	Execution Date
	HSIN-CHIEH HUANG	03/20/2014
RECEIVING PARTY DATA		
Name:	TSMC SOLID STATE LIGHTING, LTD.	
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Internal Address:	HSHINCHU SCIENCE PARK	
City:	HSINCHU	
State/Country:	TAIWAN	
Postal Code:	300-77	
PROPERTY NUMBERS Total: 1		
	Property Type	Number
	Application Number:	14210522
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ATTORNEY DOCKET NUMBER:	2009-0835-C / 48047.186	
NAME OF SUBMITTER:	DAVID M. O'DELL	
SIGNATURE:	/David M. O'Dell/	
DATE SIGNED:	05/07/2014	
Total Attachments: 2		
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ASSIGNMENT

WHEREAS, I,

(1) Hsin-Chieh Huang of 25F-2, No. 10 Beida Road
Hsin-Chu, Taiwan, R.O.C. 30044

have invented certain improvements in

LIGHT-EMITTING DEVICES WITH TEXTURED ACTIVE LAYER

for which I have executed an application for Letters Patent of the United States of America, filed on March 14, 2014 and assigned application no. 14/210,522 and;

WHEREAS, I authorize the attorney of record to update this document to include Patent Office information as deemed necessary (i.e., filing date, serial number, etc.);

WHEREAS, TSMC Solid State Lighting Ltd., 9, Li-Hsin 4th Rd., HsinChu Science Park, HsinChu, Taiwan, ROC. is desirous of obtaining the entire right, title, and interest in, to and under the said invention and the said application in the United States of America and in any and all countries foreign thereto;

NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, and other good and valuable consideration, I have sold, assigned, transferred and set over, and by these presents do hereby sell, assign, transfer and set over, unto the said TSMC, its successors, legal representatives, and assigns, the entire right, title, and interest in, to and under the said invention, and the said application, and all divisional, renewal, substitutional, and continuing applications thereof, and all Letters Patent of the United States of America which may be granted thereon and all reissues and extensions thereof, and all applications for Letters Patent which may be filed for said invention in any country or countries foreign to the United States of America, and all extensions, renewals, and reissues thereof, and all prior patents and patent applications from which a filing priority of the above-described patent application may be obtained, including the right to collect past damages; and I hereby authorize and request the Commissioner of Patents of the United States of America, and any official of any country or countries foreign to the United States of America, whose duty it is to issue patents on applications as aforesaid, to issue all Letters Patent for said invention to the said TSMC, its successors, legal representatives and assigns, in accordance with the terms of this instrument.

AND I HEREBY covenant that I have full right to convey the entire interest herein assigned, and that I have not executed, and will not execute, any agreement in conflict herewith.

AND I HEREBY further covenant and agree that I will communicate to said TSMC, its successors, legal representatives and assigns, any facts known to us respecting said invention, and testify in any legal proceedings, sign all lawful papers, execute all divisional, renewal, substitutional, continuing, and reissue applications, make all rightful declarations and/or oaths and generally do everything possible to aid the said TSMC, its successors, legal representatives and assigns, to obtain and enforce proper patent protection for said invention in all countries.

Assignment

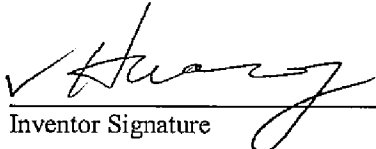
Docket No.: 2009-0835-C /48047.186

Customer No.: 42717

Inventor Name: Hsin-Chieh Huang

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✓ Dated: 2014-03-20

✓ 
Inventor Signature